

SID

Factory: Rot am See

Article:

478

ML4

Provided:

Kracht, Enrico

Customer:

Date:

08.06.2015



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
---------------	----------	----	---------	------------------

A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	1		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	310		2		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		3		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		4		
		70	L2			
C-RS-FR4-DS-1.55mm-070+070-TG150-HF	50200780	1410		5	A00	B00
		70	L3			
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	310		6		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		7		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		8		
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	9		

Thickness after Pressing

B00:

2290 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2530 µm

Dmin:

2050 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2400 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2640 µm

Dmin:

2160 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

2240 µm

Version 1.2.14.15

© Würth Elektronik